SN74CBTS3306 DUAL FET BUS SWITCH WITH SCHOTTKY DIODE CLAMPING

SCDS029E - JANUARY 1996 - REVISED NOVEMBER 1998

- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input Levels
- Package Options Include Plastic Small-Outline (D) and Thin Shrink Small-Outline (PW) Packages

description

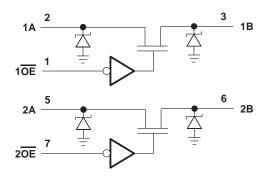
The SN74CBTS3306 features independent line switches with Schottky diodes on the I/Os to clamp undershoot. Each switch is disabled when the associated output-enable (\overline{OE}) input is high.

The SN74CBTS3306 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each bus switch)

INPUT OE	FUNCTION		
L	A port = B port		
Н	Disconnect		

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	0.5 V to 7 V
Continuous channel current	128 mA
Input clamp current, I_{IK} ($V_{I/O} < 0$)	–50 mA
Package thermal impedance, θ_{JA} (see Note 2):	D package 197°C/W
	PW package 243°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	4	5.5	V
VIH	High-level control input voltage	2		V
VIL	Low-level control input voltage		0.8	V
TA	Operating free-air temperature	-40	85	°C

NOTE 3: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PAR	AMETER	TEST CONDITIONS		MIN	TYP‡	MAX	UNIT		
Vive	A or B inputs	V00 - 45 V	I. 40 m A				-0.7	V	
VIK	Control inputs	V _{CC} = 4.5 V,	I _I = –18 mA				-1.2	V	
1.	Iլլ	$V_{CC} = 5.5 \text{ V},$	V _I = GND				-1		
t _I	I _{IH}	$V_{CC} = 5.5 \text{ V},$	V _I = 5.5 V				50	μΑ	
ICC		$V_{CC} = 5.5 \text{ V},$	$I_{O} = 0,$	$V_I = V_{CC}$ or GND			3	μΑ	
∆lcc§	Control inputs	V _{CC} = 5.5 V,	One input at 3.4 V,	Other inputs at V _{CC} or GND			2.5	mA	
Ci	Control inputs	V _I = 3 V or 0				5		pF	
C _{io(OFF)}		$V_0 = 3 \text{ V or } 0,$	OE = V _{CC}			6		pF	
r _{on} ¶		$V_{CC} = 4 \text{ V},$ TYP at $V_{CC} = 4 \text{ V}$ $V_{I} = 2.4 \text{ V},$ $I_{I} = 4 \text{ V}$	I _I = 15 mA		14	20			
			V _I = 0	I _I = 64 mA		5	7	Ω	
		V _{CC} = 4.5 V		I _I = 30 mA		5	7		
			V _I = 2.4 V,	I _I = 15 mA		10	15		

[‡] All typical values are at $V_{CC} = 5 \text{ V}$ (unless otherwise noted), $T_A = 25^{\circ}C$.



[§] This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

Measured by the voltage drop between the A and B pin at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) pins.

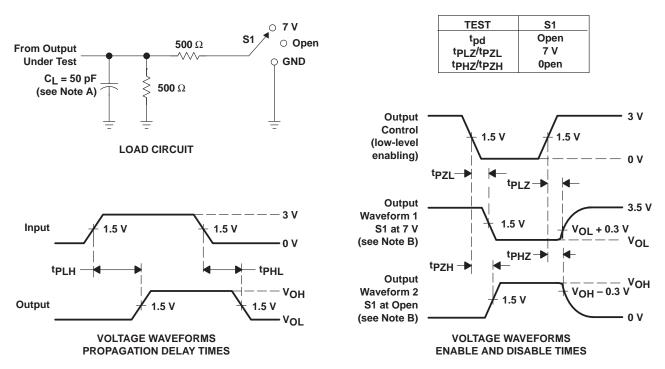
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switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4 V	V _{CC} = 5 V ± 0.5 V		UNIT
	(INPOT)		MIN MAX	MIN	MAX	
_{tpd} †	A or B	B or A	0.35		0.25	ns
t _{en}	ŌĒ	A or B	5.6	1.8	5	ns
^t dis	ŌĒ	A or B	4.6	1	4.3	ns

[†] The propagation delay is the calculated RC time constant of the typical on-state resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f \leq$ 2.5 ns. $t_f \leq$ 2.5 ns.
 - D. The outputs are measured one at a time with one transition per measurement.
 - E. tpLZ and tpHZ are the same as tdis.
 - F. tpzL and tpzH are the same as ten.
 - G. tpHL and tpLH are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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